**Product data sheet** 

## 1. General description

High voltage, high speed planar passivated NPN power switching transistor in a SOT78 (TO-220AB) plastic package.

#### 2. Features and benefits

- Fast switching
- · Low thermal resistance
- · Very high voltage capability
- · Very low switching and conduction losses

## 3. Applications

- DC-to-DC converters
- · High frequency electronic lighting ballasts
- Inverters
- Motor control systems

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CM</sub>	peak collector current	Fig. 1; Fig. 2; Fig. 3		-	-	8	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> ≤ 25 °C; <u>Fig. 4</u>		-	-	80	W
V <sub>CESM</sub>	collector-emitter peak voltage	V <sub>BE</sub> = 0 V		-	-	1050	V
Static characte	Static characteristics						
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 0.1 A; V <sub>CE</sub> = 5 V; T <sub>mb</sub> = 25 °C; Fig. 11	[1]	48	66	100	
		I <sub>C</sub> = 0.8 A; V <sub>CE</sub> = 3 V; T <sub>mb</sub> = 25 °C; Fig. 12	[1]	25	42	50	

<sup>[1]</sup> Pulse test: pulse duration  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %

**NPN** power transistor

# **5. Pinning information**

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	mb	С
2	С	collector		В
3	Е	emitter		D
mb	С	mounting base; connected to collector		E sym123
			TO-220AB (SOT78)	

# 6. Ordering information

**Table 3. Ordering information** 

Type number	Package					
	Name	Description	Version			
BUJ302A	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78			

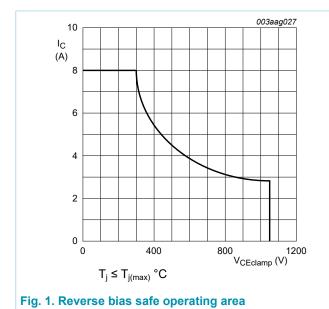
**NPN** power transistor

# 7. Limiting values

### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CESM</sub>	collector-emitter peak voltage	V <sub>BE</sub> = 0 V	-	1050	V
V <sub>CEO</sub>	collector-emitter voltage	I <sub>B</sub> = 0 A	-	400	V
V <sub>EBO</sub>	emitter-base voltage	$I_C = 0 \text{ A}; I_E = 2 \text{ A}; t_p < 10 \text{ ms}$	-	24	V
I <sub>C</sub>	collector current	Fig. 1; Fig. 2; Fig. 3	-	4	Α
I <sub>CM</sub>	peak collector current		-	8	Α
I <sub>B</sub>	base current		_	2	Α
I <sub>BM</sub>	peak base current		-	4	Α
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> ≤ 25 °C; <u>Fig. 4</u>	-	80	W
T <sub>stg</sub>	storage temperature		-65	150	°C
T <sub>j</sub>	junction temperature		-	150	°C



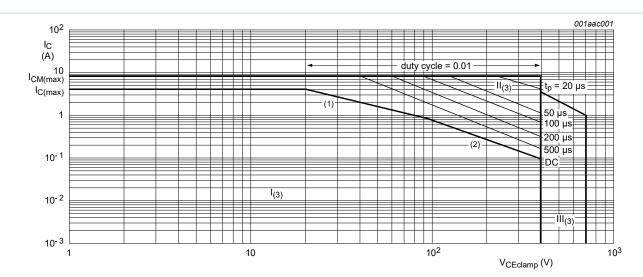
VCC
LC
VCL(CE)
probe point
VBB

O01aab999

$$\begin{split} &V_{CL(CE)} \leq 1000 \text{ V; } V_{CC} = 150 \text{ V; } V_{BB} = \text{--} 5 \text{ V;} \\ &L_{B} = 1 \text{ } \mu\text{H; } L_{C} = 200 \text{ } \mu\text{H} \end{split}$$

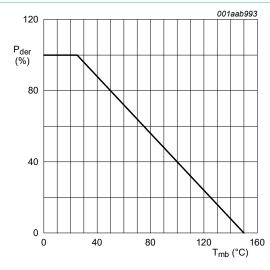
Fig. 2. Test circuit for reverse bias safe operating area

#### **NPN** power transistor



- 1) Ptot maximum and Ptot peak maximum lines
- 2) Second breakdown limits
- 3) I = Region of permissable DC operation
  - II = Extension for repetitive pulse operation
  - III = Extension during turn-on in single transistor converters provided that  $R_{BE} \le 100~\Omega$  and  $t_p \le 0.6~\mu s$

Fig. 3. Forward bias safe operating area for  $T_{mb} \le 25~^{\circ}\text{C}$ 



$$P_{der} = \frac{P_{tot}}{P_{tot}(25^{\circ}C)} \times 100\%$$

Fig. 4. Normalized total power dissipation as a function of mounting base temperature

**NPN** power transistor

### 8. Thermal characteristics

**Table 5. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Fig. 5	-	-	1.56	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

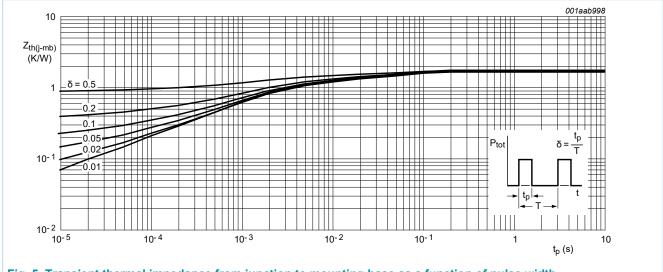


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse width

5 / 12

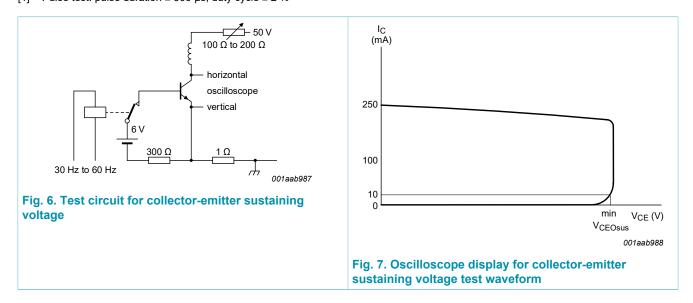
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### 9. Characteristics

**Table 6. Characteristics** 

able 6. Cha	racteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static chara	cteristics			,			,
I <sub>CES</sub>	collector-emitter cut-off current (base shorted)	V <sub>BE</sub> = 0 V; V <sub>CE</sub> = 1050 V; T <sub>mb</sub> = 25 °C		-	0.2	10	μA
I <sub>CEO</sub>	collector-emitter cut-off current (base open)	$V_{CE} = 400 \text{ V}; I_{B} = 0 \text{ A}; T_{mb} = 25 \text{ °C}$		-	10	250	mA
$V_{(BR)EBO}$	emitter-base breakdown voltage (collector open)	$I_B = 1 \text{ mA}; I_C = 0 \text{ A}; T_{mb} = 25 \text{ °C}$		15	19	-	V
$V_{CEOsus}$	collector-emitter sustaining voltage (base open)	$I_B = 0 \text{ A}; I_C = 10 \text{ mA}; L_C = 25 \text{ mH};$ $T_{mb} = 25 ^{\circ}\text{C}; Fig. 6; Fig. 7$	[1]	400	470	-	V
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 1 \text{ A}$ ; $I_B = 0.2 \text{ A}$ ; $T_{mb} = 25 \text{ °C}$ ; <u>Fig. 8</u> ; <u>Fig. 9</u>	[1]	-	0.15	0.5	V
		$I_C = 3.5 \text{ A}$ ; $I_B = 1 \text{ A}$ ; $T_{mb} = 25 \text{ °C}$ ; <u>Fig. 8</u> ; <u>Fig. 9</u>	[1]	-	0.6	1.5	V
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 3.5 \text{ A}$ ; $I_B = 1 \text{ A}$ ; $T_{mb} = 25 ^{\circ}\text{C}$ ; Fig. 10	[1]	-	1.1	1.5	V
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 0.1 A; V <sub>CE</sub> = 5 V; T <sub>mb</sub> = 25 °C; Fig. 11	[1]	48	66	100	
		$I_C = 0.8 \text{ A}; V_{CE} = 3 \text{ V}; T_{mb} = 25 ^{\circ}\text{C};$ Fig. 12	[1]	25	42	50	
Dynamic ch	aracteristics					,	
t <sub>s</sub>	storage time	I <sub>C</sub> = 2.5 A; I <sub>Bon</sub> = 0.5 A; I <sub>Boff</sub> = -0.5 A;		-	-	3.5	μs
t <sub>f</sub>	fall time	R <sub>L</sub> = $60 \Omega$ ; V <sub>BB</sub> = $-5 V$ ; T <sub>mb</sub> = $25 ^{\circ}$ C; resistive load; t <sub>p</sub> = $300 \mu$ s; <u>Fig. 13</u> ; <u>Fig. 14</u>		-	-	500	ns
		<u> </u>					

#### [1] Pulse test: pulse duration ≤ 300 µs, duty cycle ≤ 2 %



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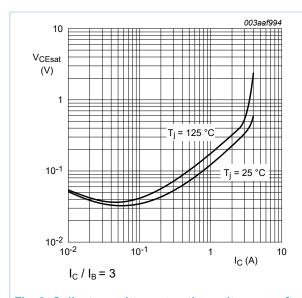


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

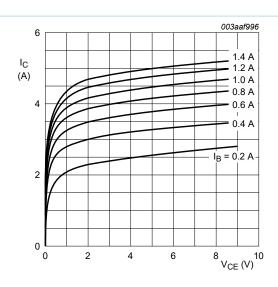


Fig. 9. Collector current as a function of collectoremitter voltage; typical values

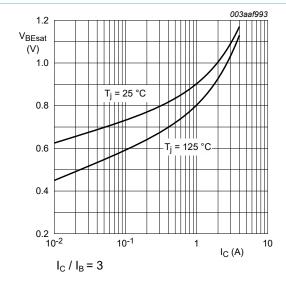


Fig. 10. Base-emitter saturation voltage as a function of collector current; typical values

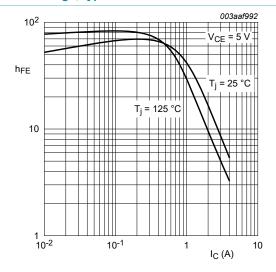


Fig. 11. DC current gain as a function of collector current; typical values

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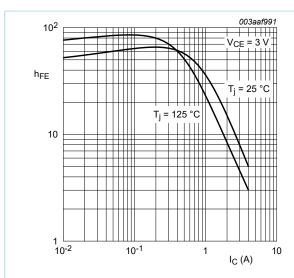


Fig. 12. DC current gain as a function of collector current; typical values

 $V_{IM}$ = - 6 to + 8 V;  $V_{CC}$  = 250 V;  $t_p$  = 20 us;  $\delta$  =  $t_p$ /T = 0.01  $R_B$  and  $R_L$  calculated from  $I_{Con}$  and  $I_{Bon}$  requirements.

Fig. 13. Test circuit for resistive load switching

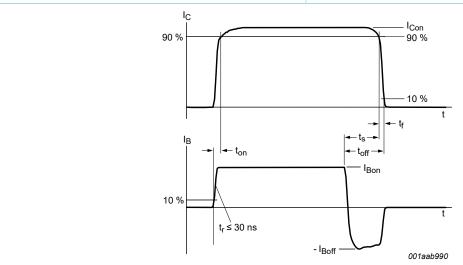
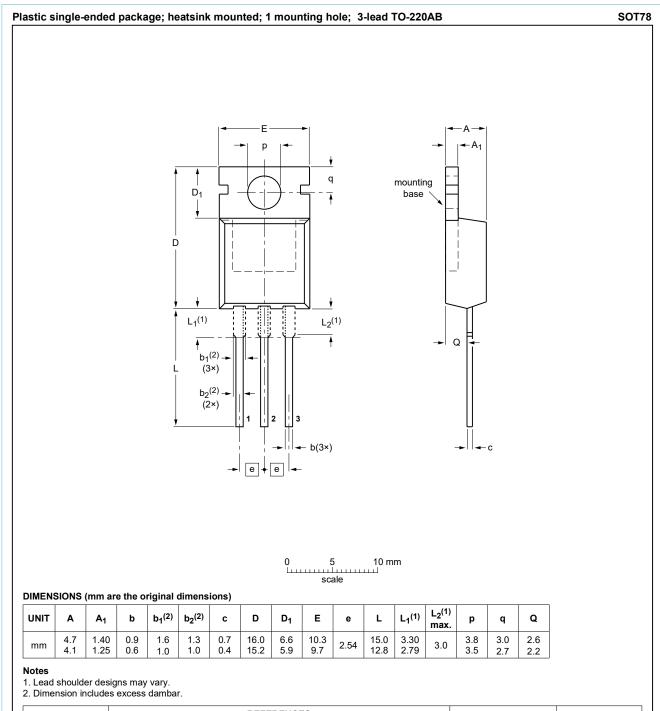


Fig. 14. Switching times waveforms for resistive load

**NPN** power transistor

## 10. Package outline



	EUROPEAN	ISSUE DATE
VERSION IEC JEDEC JEITA	PROJECTION	ISSUE DATE
SOT78 3-lead TO-220AB SC-46		<del>08-04-23</del> 08-06-13

Fig. 15. Package outline TO-220AB (SOT78)

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## 11. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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**NPN** power transistor

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## **NPN** power transistor

**BUJ302A** 

### 12. Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Limiting values	3
8.	Thermal characteristics	5
9.	Characteristics	6
10	. Package outline	9
11	. Legal information	10

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